

**PLEASE AMEND THE SPECIFICATION AS FOLLOWS:**

After the title, insert -*This is a division of Patent Application serial number  
now Patent 6,211,050 B1  
09261,681, filing date 3/3/99, A Fill Pattern In Kerf Areas To Prevent Localized  
Non-Uniformities Of Insulating Layers At Die Corners On Semiconductor Substrates,  
assigned to the same assignee as the present invention.*

**REMARKS**

A reference to the parent case has been added by Preliminary Amendment to this  
Divisional Patent Application.

The application is believed to be in condition for allowance. Allowance of the  
subject Patent Application is therefore respectfully requested.

Respectfully submitted,



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